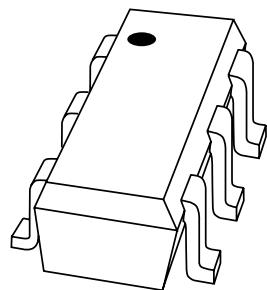


DATA SHEET



BGA2012

**1900 MHz high linear low noise
amplifier**

Preliminary specification

2000 Aug 18

**Philips
Semiconductors**



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1900 MHz high linear low noise amplifier**BGA2012****FEATURES**

- Low current, low voltage
- High linearity
- High power gain
- Low noise
- Integrated temperature compensated biasing
- Control pin for adjustment bias current.

PINNING

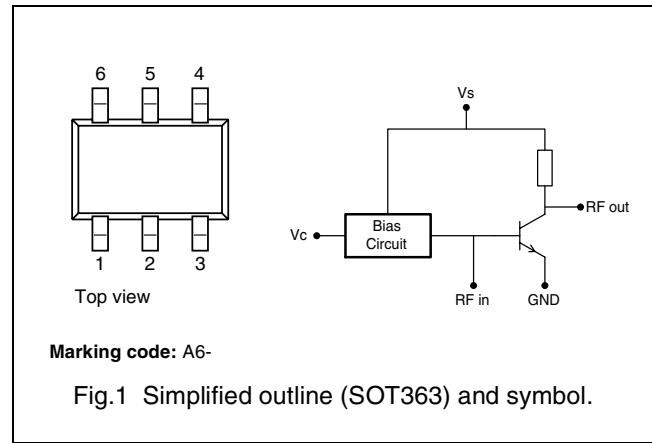
PIN	DESCRIPTION
1	RF in
2	V_C
3	V_S
4	RF out
5, 6	GND

APPLICATIONS

- RF front end
- Low noise amplifiers, e.g. CDMA, PHs, Dect, etc.

DESCRIPTION

Silicon Monolithic Microwave Integrated Circuit (MMIC) amplifier consisting of an NPN double polysilicon transistor with integrated biasing for low voltage applications in a 6-pin SOT363 plastic SMD package.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_S	DC supply voltage	RF input AC coupled	3	4.5	V
I_S	DC supply current		7.5	—	mA
I_C	DC control current	$V_C = V_S$	0.11	—	mA
$ IS_{21} ^2$	insertion power gain	in application circuit of Fig.2; $f = 1900$ MHz	16	—	dB
NF	noise figure	$I_S = 7$ mA; $f = 1900$ MHz	1.7	—	dB

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_S	DC supply voltage	RF input AC coupled	—	4.5	V
V_C	voltage on control pin		—	V_S	V
I_S	supply current	forced by DC voltage on RF input	—	15	mA
I_C	control current		—	0.25	mA
P_{tot}	total power dissipation	$T_s \leq 100$ °C	—	70	mW
T_{stg}	storage temperature		-65	+150	°C
T_j	operating junction temperature		—	150	°C

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THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to solder point	$P_{tot} = 135 \text{ mW}; T_s \leq 100 \text{ }^\circ\text{C}$	350	K/W

CHARACTERISTICSRF input AC coupled; $V_S = 3 \text{ V}$; $I_S = 7 \text{ mA}$; $f = 1900 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_S	supply current		5	7.5	10	mA
I_C	control current		–	0.11	–	mA
$R_{L\ IN}$	return losses input	typical application (see Fig.2)	–	-11	–	dB
		high IP3 (see Fig.2; stripline = 0 mm)	–	-20	–	dB
		high IP3 (see Fig.2; stripline = 0.5 mm)	–	-14	–	dB
$R_{L\ OUT}$	return losses output	typical application (see Fig.2)	–	-9	–	dB
		high IP3 (see Fig.2; stripline = 0 mm)	–	-10	–	dB
		high IP3 (see Fig.2; stripline = 0.5 mm)	–	-8	–	dB
$ IS_{21} ^2$	insertion power gain	typical application (see Fig.2)	–	14	–	dB
		high IP3 (see Fig.2; stripline = 0 mm)	–	16	–	dB
		high IP3 (see Fig.2; stripline = 0.5 mm)	–	14	–	dB
NF	noise figure	typical application (see Fig.2); $I_S = 7 \text{ mA}$	–	1.7	–	dB
		high IP3 (see Fig.2; stripline = 0 mm)	–	2.2	–	dB
		high IP3 (see Fig.2; stripline = 0.5 mm)	–	2.3	–	dB
$IP3_{(in)}$	input intercept point	typical application (see Fig.2)	–	-7	–	dBm
		high IP3 (see Fig.2; stripline = 0 mm)	–	7	–	dBm
		high IP3 (see Fig.2; stripline = 0.5 mm)	–	10	–	dBm

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ELECTRICAL BLOCK DIAGRAM

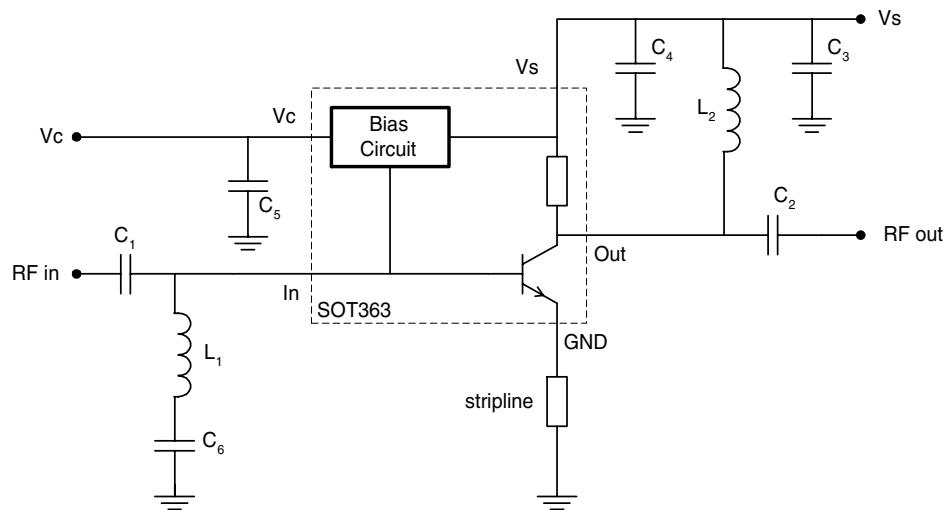


Fig.2 Application circuit

List of components (see Fig.2)

COMPONENT	DESCRIPTION	TYPICAL APPLICATION	HIGH IP3 APPLICATION	DIMENSIONS
C1, C2	multilayer ceramic chip capacitor	100 pF	100 pF	0603
C3, C5	multilayer ceramic chip capacitor	22 nF	22 nF	0603
C4	multilayer ceramic chip capacitor	—	—	—
C6	multilayer ceramic chip capacitor	—	100 nF	0805
L1	SMD inductor	—	3.9 nH	0603
L2	SMD inductor	—	3.9 nH	0603

Note

1. The stripline is on a gold plated double copper-clad printed-circuit board ($\epsilon_r = 6.15$), board thickness = 0.64 mm, copper thickness = 35 μm , gold thickness = 5 μm .

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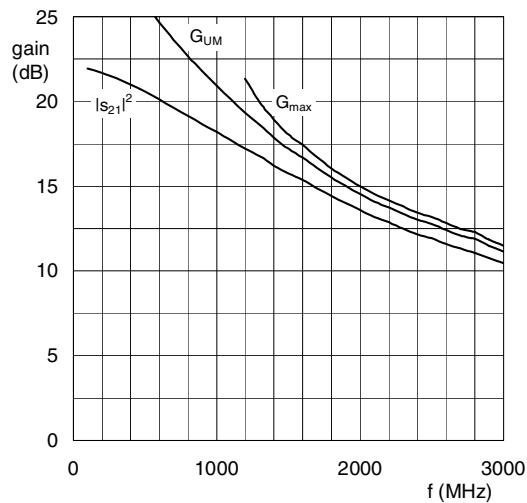
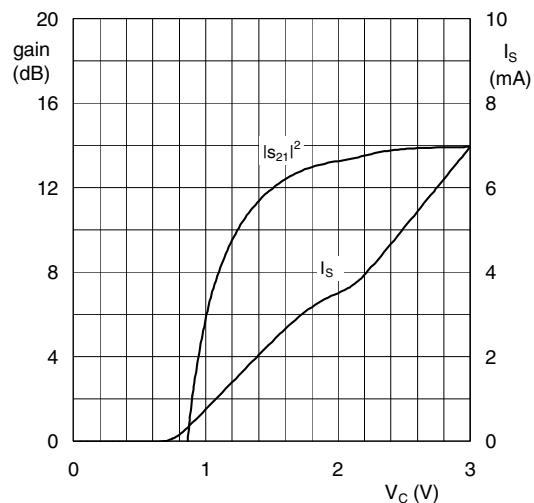
 $I_C = 7 \text{ mA}; V_S = V_C = 3 \text{ V}; P_D = -30 \text{ dBm}; Z_o = 50 \Omega$.Fig.3 Insertion gain ($|s_{21}|^2$), G_{UM} and G_{max} as function of frequency; typical values. $f = 1900 \text{ MHz}; V_S = 3 \text{ V}; P_D = -30 \text{ dBm}$.

Fig.4 Insertion gain and supply current as function of control voltage; typical values.

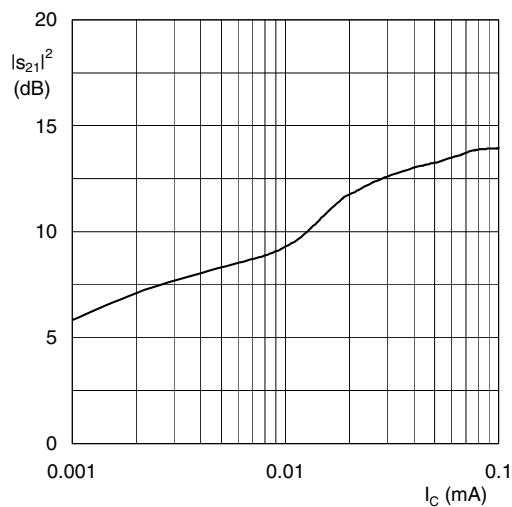
 $f = 1900 \text{ MHz}; V_S = 3 \text{ V}; P_D = -30 \text{ dBm}$.

Fig.5 Insertion gain as a function of control current; typical values.

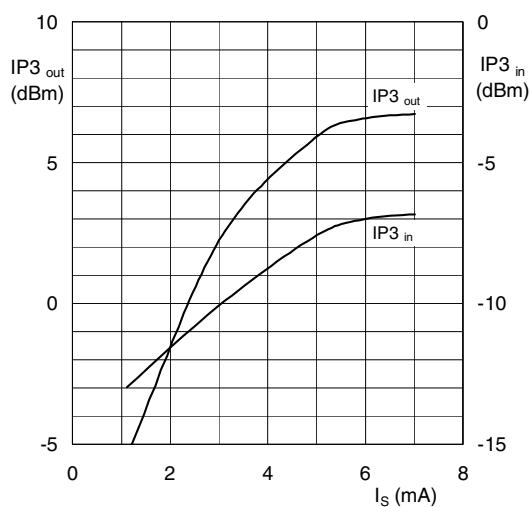
 $V_S = V_C = 3 \text{ V}; P_D = -30 \text{ dBm} (\text{both tones}); f = 1900 \text{ MHz}; \Delta f = 100 \text{ kHz}$

Fig.6 Output and input 3rd order intercept point as function of the supply current; typical application; typical values.

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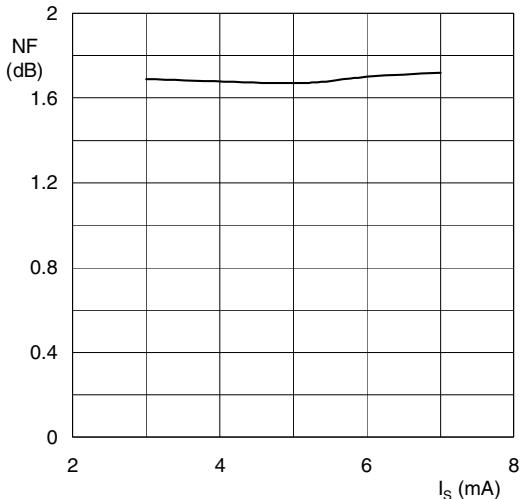
 $V_S = V_C = 3$ V; $f = 1900$ MHz.

Fig.7 Noise figure as a function of the supply current; typical values.

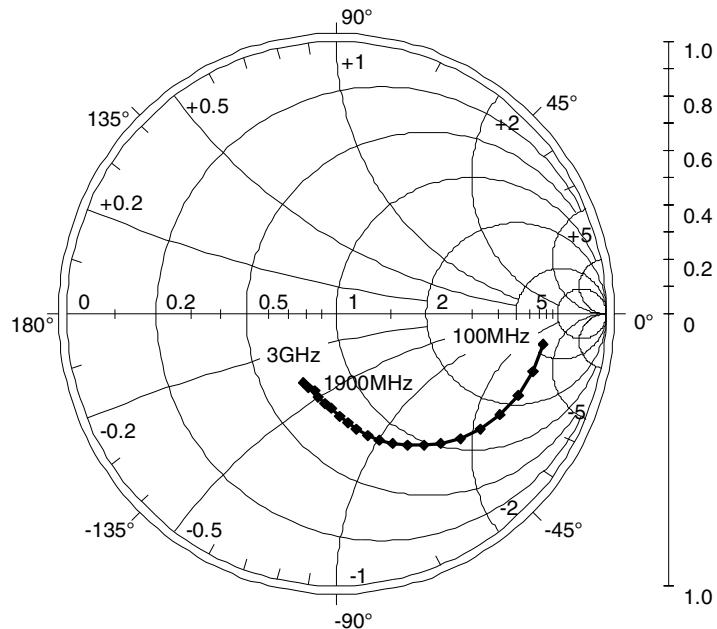
Scattering parameters

 $V_S = V_C = 3$ V; $P_D = -30$ dBm; $Z_o = 50 \Omega$; $T_{amb} = 25$ °C

f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)
100	0.775	-8.390	12.527	171.1	0.005	84.90	0.742	-6.684
200	0.761	-16.37	12.154	163.1	0.011	79.39	0.731	-13.15
400	0.709	-31.51	11.213	148.6	0.020	72.23	0.689	-24.85
600	0.646	-44.97	10.139	136.4	0.028	66.03	0.631	-34.90
800	0.581	-56.47	9.061	126.1	0.034	61.82	0.573	-43.40
1000	0.519	-66.59	8.131	117.3	0.039	58.86	0.519	-50.54
1200	0.461	-75.41	7.254	109.5	0.043	58.07	0.469	-57.19
1400	0.401	-83.99	6.461	103.1	0.047	57.92	0.428	-64.08
1600	0.350	-93.12	5.869	96.39	0.051	57.26	0.396	-70.03
1800	0.313	-102.0	5.256	90.46	0.054	57.37	0.369	-75.33
2000	0.289	-110.6	4.778	85.58	0.058	58.10	0.348	-80.47
2200	0.278	-118.5	4.394	81.16	0.062	57.66	0.336	-85.37
2400	0.276	-125.0	4.051	77.28	0.066	56.08	0.333	-89.83
2600	0.286	-131.9	3.793	74.34	0.072	60.98	0.316	-92.61
2800	0.293	-136.5	3.571	70.27	0.076	60.21	0.308	-94.44
3000	0.287	-141.6	3.326	67.39	0.083	61.36	0.272	-99.52

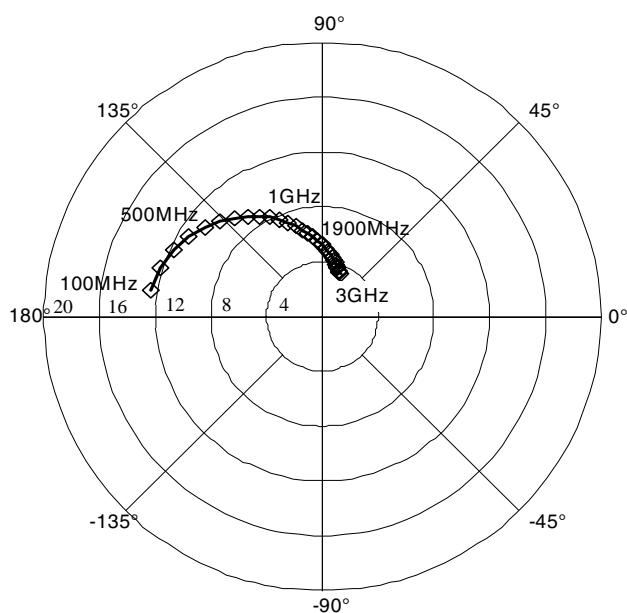
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$I_C = 7 \text{ mA}$; $V_S = V_C = 3 \text{ V}$; $P_D = -30 \text{ dBm}$; $Z_0 = 50 \Omega$.

Fig.8 Common emitter input reflection coefficient (S_{11}); typical values.

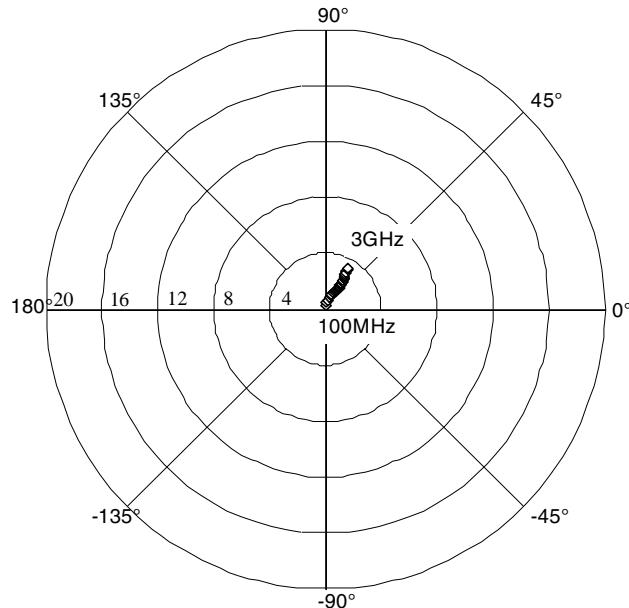
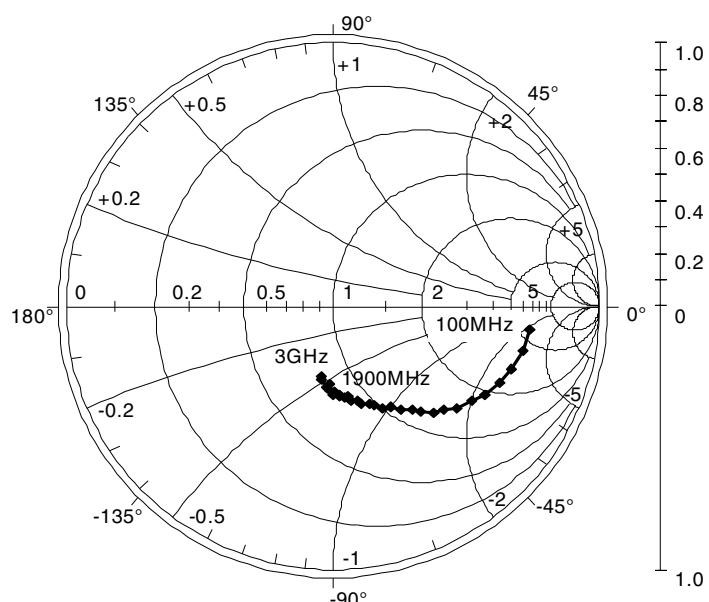


$I_C = 7 \text{ mA}$; $V_S = V_C = 3 \text{ V}$; $P_D = -30 \text{ dBm}$; $Z_0 = 50 \Omega$.

Fig.9 Common emitter forward transmission coefficient (S_{21}); typical values.

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 $I_C = 7 \text{ mA}; V_S = V_C = 3 \text{ V}; P_D = -30 \text{ dBm}; Z_o = 50 \Omega.$ Fig.10 Common emitter reverse transmission coefficient (S_{12}); typical values. $I_C = 7 \text{ mA}; V_S = V_C = 3 \text{ V}; P_D = -30 \text{ dBm}; Z_o = 50 \Omega.$ Fig.11 Common emitter output reflection coefficient (S_{22}); typical values.

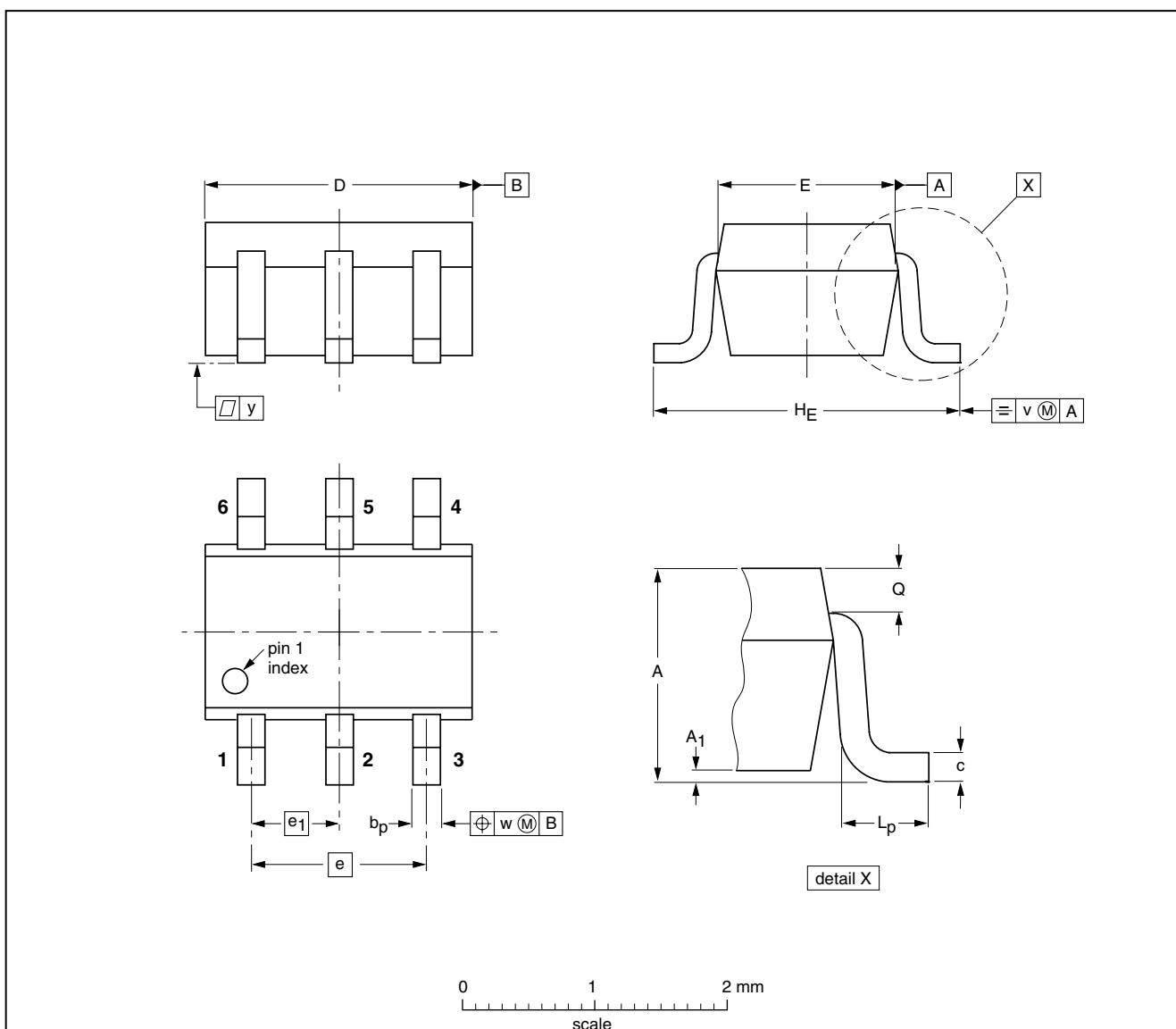
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT363



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ	SC-88		
SOT363						97-02-28

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Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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